

In The Specification

Paragraph 007 has been amended as follows:

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A, 007 Figures 1B and 1C illustrate another typical wafer blade 30 used in transporting 200 mm wafers. The wafer blade 30 generally has a dimension of 150 mm length and 70 mm width. The wafer blade 30 is constructed of a blade body 32 of generally elongated rectangular shape and formed of a rigid metallic material such as aluminum or stainless steel. At a base portion 34 of the blade body 32, mounting means 36 which are screw holes is provided for attaching to a robot arm (not shown). Figure 1B shows the back side surface 38 of the blade body 32 which further contains a vacuum passageway 42, i.e., a channel formed in the blade body 32 and sealed by a cover 44. At a base portion 34 of the blade body 32, the vacuum passageway 42 is in fluid communication with an external vacuum source (not shown) through a vacuum inlet 46. At the front portion 48 of the blade body 32, the vacuum passageway 42 is in fluid communication with a recessed vacuum port 50 through a vacuum opening 52. A side view of the blade body 32 is shown in Figure 1C.